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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO. 9919
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ALEXANDRIA, VA 22314			ART UNIT	PAPER NUMBER
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Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

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•		Applicatio	n No.	Applicant(s)			
Office Action Summary		10/519,406	3	DI CIOCCIO ET AL.			
		Examiner		Art Unit			
		Colleen E.	Rodgers	2813			
The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply							
WHIC - Exter after - If NC - Failu Any	ORTENED STATUTORY PERIOD FOR REPLY CHEVER IS LONGER, FROM THE MAILING DANSIONS of time may be available under the provisions of 37 CFR 1.13 SIX (6) MONTHS from the mailing date of this communication, operiod for reply is specified above, the maximum statutory period were to reply within the set or extended period for reply will, by statute, reply received by the Office later than three months after the mailing and patent term adjustment. See 37 CFR 1.704(b).	ATE OF TH 36(a). In no ever will apply and will , cause the appli	IS COMMUNICATION ont, however, may a reply be time expire SIX (6) MONTHS from cation to become ABANDONEI				
Status							
1)⊠	Responsive to communication(s) filed on <u>06 August 2007</u> .						
2a)⊠	This action is FINAL . 2b) ☐ This action is non-final.						
3)	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.						
Dispositi		,	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,				
A) ☐ Claim(s) 8-15 is/are pending in the application. 4a) Of the above claim(s) is/are withdrawn from consideration. 5) ☐ Claim(s) is/are allowed. 6) ☐ Claim(s) 8-15 is/are rejected. 7) ☐ Claim(s) is/are objected to. 8) ☐ Claim(s) are subject to restriction and/or election requirement.							
Applicat	ion Papers			•			
10)	The specification is objected to by the Examine The drawing(s) filed on is/are: a) accomplicant may not request that any objection to the Replacement drawing sheet(s) including the correct The oath or declaration is objected to by the Examine	epted or b)[drawing(s) bo tion is require	e held in abeyance. See d if the drawing(s) is obj	e 37 CFR 1.85(a). jected to. See 37 CFR 1.121(d).			
Priority (under 35 U.S.C. § 119						
 12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) All b) Some * c) None of: 1. Certified copies of the priority documents have been received. 2. Certified copies of the priority documents have been received in Application No. 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received. 							
2) Notice 3) Infor	et(s) ce of References Cited (PTO-892) ce of Draftsperson's Patent Drawing Review (PTO-948) mation Disclosure Statement(s) (PTO/SB/08) er No(s)/Mail Date		4) Interview Summary Paper No(s)/Mail Da 5) Notice of Informal P 6) Other:	ate			

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DETAILED ACTION

1. This Office Action responds to the Amendment filed 6 August 2007. By this amendment, claim 8 is amended and claim 15 is newly added.

Claim Rejections - 35 USC § 103

- 2. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 3. Claims 8-12, 14 and 15 are rejected under 35 U.S.C. 103(a) as being unpatentable over Goesele et al (USPN 6,150,239) in view of Usenko (USPN 6,995,075).

Regarding claim 8, **Goesele et al** disclose a method for transferring an electrically active thin film from an initial substrate to a target substrate, comprising:

ion implantation through one face of the initial substrate to create a buried, embrittled film at a determined depth in relation to the implanted face of the initial substrate, a thin film thus being delimited between the implanted face and the buried face [see col. 4, lines 24-29 and lines 56-59];

fastening the implanted face of the initial substrate with a face of the target substrate [see col. 5, lines 12-14];

separating the thin film from a remainder of the initial substrate at a level of the buried film [see col. 5, lines 15-25].

Goesele et al do not disclose a step of thinning down the thin film transferred on the target substrate. Usenko discloses a method of forming a thin film 111 on a target substrate 107 by

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delamination of a layer 111 from an initial substrate 101 [see Fig. 1]. Furthermore, Usenko discloses thinning the layer 111 [see col. 1, lines 58-61]. It would have been obvious to one of ordinary skill in the art at the time of invention to thin the layer because Usenko teaches that it removes the worst quality part of the layer [see col. 2, lines 44-49].

Furthermore, Goesele et al do not specify wherein the implantation dosage, energy and current are chosen, during the ion implantation, so that concentration of implantation defects is less than a determined threshold, resulting in, within the thinned down thin film, a number of acceptor defects that is compatible with desired electrical properties of the thin film. However, this constitutes routine optimization of process parameters to achieve a result. Generally, differences in concentration or temperature will not support the patentability of subject matter encompassed by the prior art unless there is evidence indicating such concentration or temperature is critical. "Where the general conditions of a claim are disclosed in the prior art, it is not inventive to discover the optimum or workable ranges by routine experimentation." See *In re Aller*, 220 F.2d 454, 456, 105 USPQ 233, 235 (CCPA 1955).

Regarding claim 9, the prior art of Goesele et al and Usenko disclose the method according to claim 8. Furthermore, Goesele et al disclose wherein the ion implantation includes implanting ions chosen from among the following species: hydrogen and rare gases [see col. 6, lines 29-33].

Regarding claim 10, the prior art of **Goesele et al** and **Usenko** disclose the method according to claim 8. Furthermore, **Goesele et al** disclose wherein the fastening includes direct wafer bonding, which comprises molecular adhesion [see col. 5, lines 12-14].

Regarding claim 11, the prior art of **Goesele et al** and **Usenko** disclose the method according to claim 8. Furthermore, **Goesele et al** disclose a step of healing annealing of the implantation defects on the thin film [see col. 5, lines 15-17].

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Regarding claim 12, the prior art of Goesele et al and Usenko disclose the method according to claim 8. Furthermore, Goesele et al disclose wherein the healing annealing is carried out before the separating the thin film from a remainder of the initial substrate, which is carried out before the healing annealing step of Usenko [see Goesele et al, col. 5, lines 15-25; see also Usenko, col. 2, lines 44-49].

Regarding claim 14, the prior art of Goesele et al and Usenko disclose the method according to claim 8. Furthermore, Goesele et al disclose wherein application of the method according to claim 8 to obtain a thin film of SiC or diamond [see col. 3, line 66 to col. 4, line 2].

Regarding claim 15, the prior art of Goesele et al and Usenko disclose the method according to claim 14. Neither Goesele et al nor Usenko disclose wherein the thickness of the SiC film is less than or equal to 0.5 µm nor wherein the concentration of defects is less than 9 x 10²⁰ atoms/cm³. However, these claims are *prima facie* obvious without a showing that the claimed ranges achieve unexpected results relative to the prior art range. *In re Woodruff*, 16 USPQ2d 1935, 1937 (Fed. Cir. 1990). See also *In re Huang*, 40 USPQ2d 1685, 1688 (Fed. Cir. 1996) (claimed ranges of a result effective variable, which do not overlap the prior art ranges, are unpatentable unless they produce a new and unexpected result which is different in kind and not merely in degree from the results of the prior art). See also *In re Boesch*, 205 USPQ 215 (CCPA) (discovery of optimum value of result effective variable in known process is ordinarily within skill of art) and *In re Aller*, 105 USPQ 233 (CCPA 1955) (selection of optimum ranges within prior art in general conditions is obvious). In this case, there exists no evidence of record that the thickness of the SiC film or the concentration of defects provides unexpected results in the thin film produced. One of ordinary skill in the art would be motivated to optimize the thickness of the SiC and the concentration of defects to provide for device performance and processing limitations.

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4. Claim 13 is rejected under 35 U.S.C. 103(a) as being unpatentable over Goesele et al (USPN 6,150,239) in view of Usenko (USPN 6,995,075) as applied to claims 8-12, 14 and 15 above, and further in view of Maleville et al (USPN 6,403,450). The prior art of Goesele et al and Usenko disclose the method according to claim 8. Neither Goesele et al nor Usenko disclose wherein the healing annealing is carried out after the thinning down the thin film. Maleville et al disclose a method of thinning a semiconductor layer by formation of a sacrificial oxide, followed by an healing annealing step [see col. 7, lines 23-30]. It would have been obvious to one of ordinary skill in the art at the time of invention to include a healing annealing step after the thinning process because Maleville et al teach that it heals the defects generated by the formation of the surface oxide layer and stabilizes the bonding interface [see col. 7, lines 23-30].

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Response to Arguments

5. Applicant's arguments filed 6 August 2007 have been fully considered but they are not persuasive. On page 5 of the Remarks, Applicants allege, "Goesele does not teach or suggest that a buried film and a thin film are formed in the first substrate as required by independent Claim 8.

Goesele discloses the formation of only the thin film and not the buried film" (see page 5).

The Examiner respectfully disagrees. The implantation taught by **Goesele et al** forms a brittle buried film at the depth to which the hydrogen-trap inducing element is implanted [see col. 4, lines 24-29]. Above this brittle buried film is the thin film of defect-free silicon carbide, diamond, or other substrate material [see col. 3, line 67 to col. 4, line 2]. The rejection stands as outlined above.

Furthermore, on pages 5-6 of the Remarks, Applicants allege that the act of selecting the quantities of implantation dosage, energy and current "is uniquely challenging or difficult for one of ordinary skill in the art, which does not indicate routine experimentation as suggested" (see page 6).

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The Examiner respectfully submits that a mere statement that the selection of the quantities in question is difficult and beyond the scope of routine experimentation by one of ordinary skill in the art does not constitute a legal showing that the claimed quantities are non-obvious. Therefore, the rejection stands.

Conclusion

6. THIS ACTION IS MADE FINAL. Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Colleen E. Rodgers whose telephone number is (571) 272-8603. The examiner can normally be reached on Monday through Friday, 9:00 AM to 6:00 PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Carl Whitehead can be reached on (571) 272-1702. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

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CER

CARL WHITEHEAD, JR.

PERVISORY PATENT EXAMINER

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